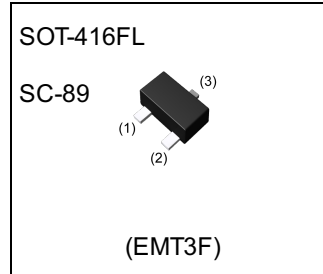


| Parameter | Value |
|---------------|--------------|
| V_{CC} | 50V |
| $I_{C(MAX.)}$ | 100mA |
| R_1 | 47k Ω |
| R_2 | 47k Ω |

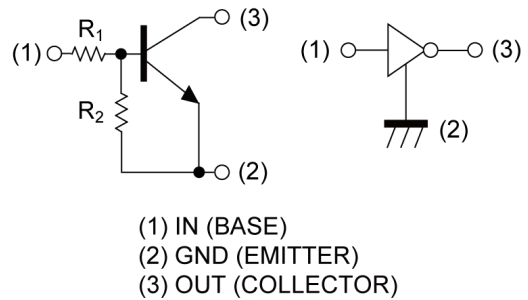
●Outline



●Features

- 1) Built-In Biasing Resistors, $R_1 = R_2 = 47k\Omega$
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit) .
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary PNP Types: DTA144EEB HZG

●Inner circuit



●Application

INVERTER, INTERFACE, DRIVER

●Packaging specifications

| Part No. | Package | Package size | Taping code | Reel size (mm) | Tape width (mm) | Basic ordering unit.(pcs) | Marking |
|---------------|-------------------|--------------|-------------|----------------|-----------------|---------------------------|---------|
| DTC144EEB HZG | SOT-416FL (EMT3F) | 1616 | TL | 180 | 8 | 3000 | 26 |

● **Absolute maximum ratings** ($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Values | Unit |
|------------------------------|-------------------|-------------|------------------|
| Supply voltage | V_{CC} | 50 | V |
| Input voltage | V_{IN} | -10 to 40 | V |
| Output current | I_O | 30 | mA |
| Collector current | $I_{C(MAX)}^{*1}$ | 100 | mA |
| Power dissipation | P_D^{*2} | 150 | mW |
| Junction temperature | T_j | 150 | $^\circ\text{C}$ |
| Range of storage temperature | T_{stg} | -55 to +150 | $^\circ\text{C}$ |

● **Electrical characteristics** ($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Conditions | Values | | | Unit |
|----------------------|--------------|--|--------|------|------|---------------|
| | | | Min. | Typ. | Max. | |
| Input voltage | $V_{I(off)}$ | $V_{CC} = 5V, I_O = 100\mu\text{A}$ | - | - | 0.5 | V |
| | $V_{I(on)}$ | $V_O = 0.3V, I_O = 2\text{mA}$ | 3.0 | - | - | |
| Output voltage | $V_{O(on)}$ | $I_O = 10\text{mA}, I_I = 0.5\text{mA}$ | - | 100 | 300 | mV |
| Input current | I_I | $V_I = 5V$ | - | - | 180 | μA |
| Output current | $I_{O(off)}$ | $V_{CC} = 50V, V_I = 0V$ | - | - | 500 | nA |
| DC current gain | G_I | $V_O = 5V, I_O = 5\text{mA}$ | 68 | - | - | - |
| Input resistance | R_I | - | 32.9 | 47 | 61.1 | k Ω |
| Resistance ratio | R_2/R_1 | - | 0.8 | 1.0 | 1.2 | - |
| Transition frequency | f_T^{*1} | $V_{CE} = 10V, I_E = -5\text{mA}, f = 100\text{MHz}$ | - | 250 | - | MHz |

*1 Characteristics of built-in transistor

*2 Each terminal mounted on a reference land.

● Electrical characteristic curves ($T_a = 25^\circ\text{C}$)

Fig.1 Input voltage vs. output current (ON characteristics)

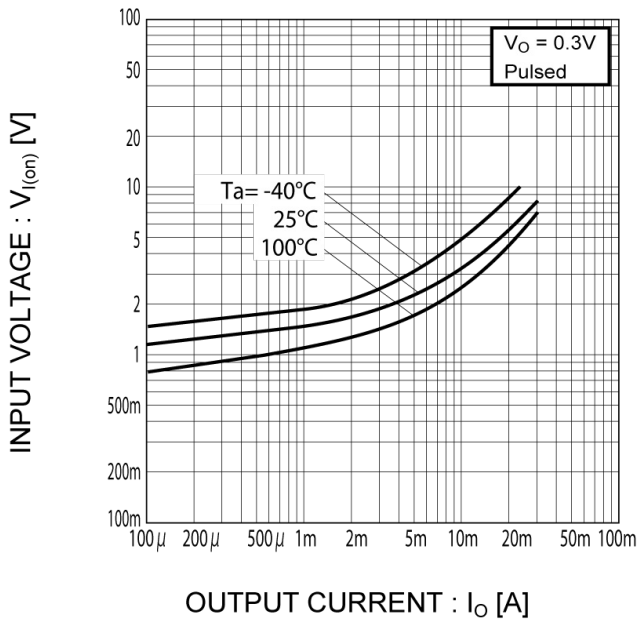


Fig.2 Output current vs. input voltage (OFF characteristics)

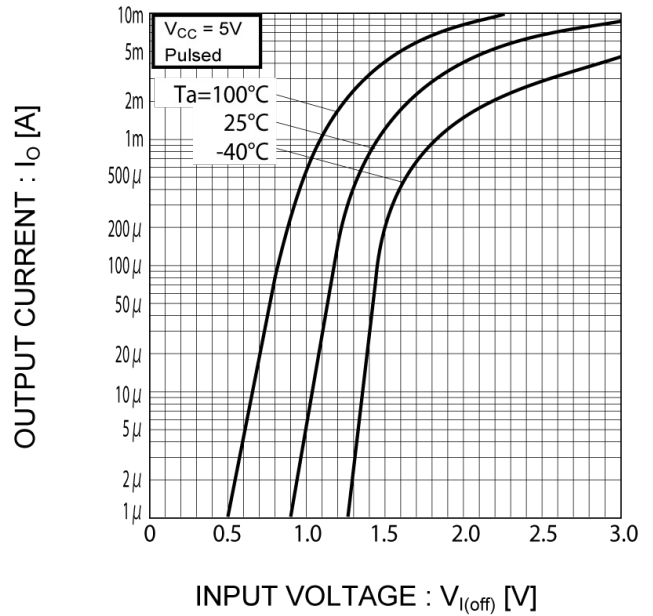


Fig.3 Output current vs. output voltage

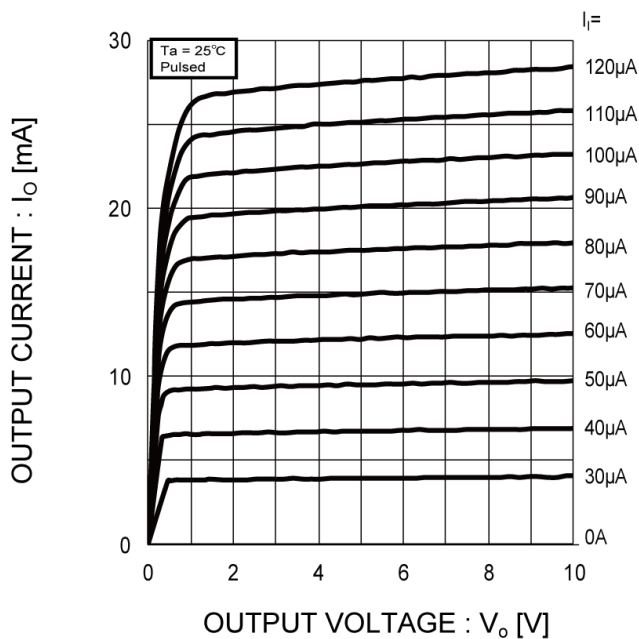
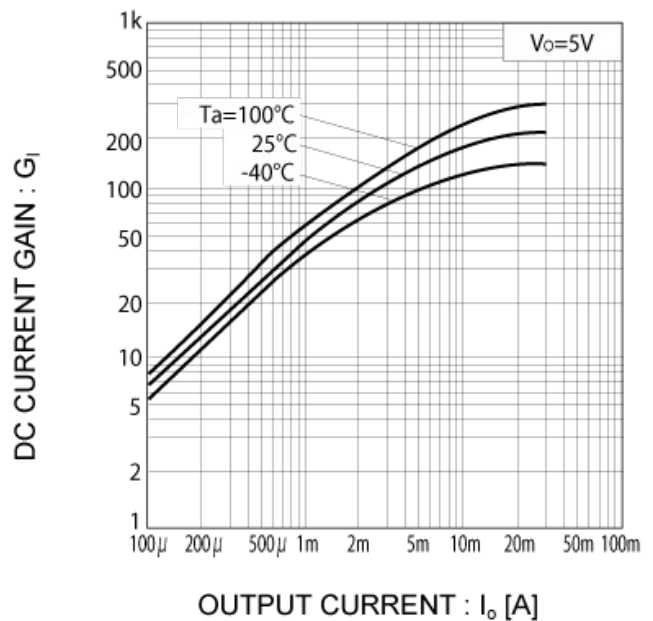
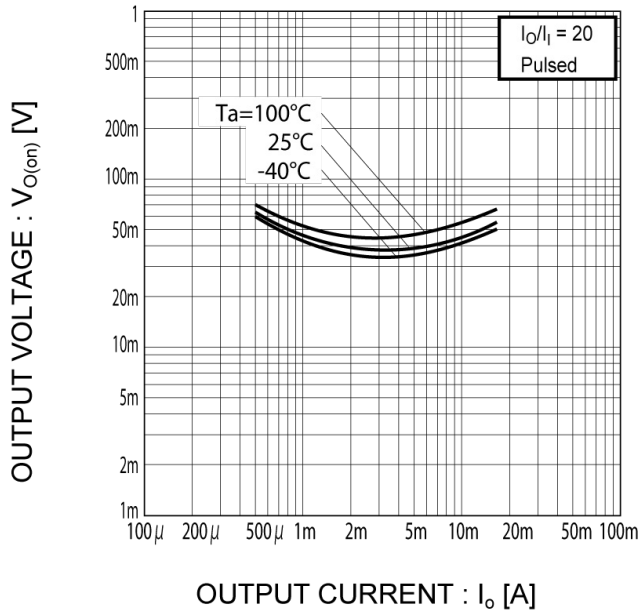


Fig.4 DC current gain vs. output current



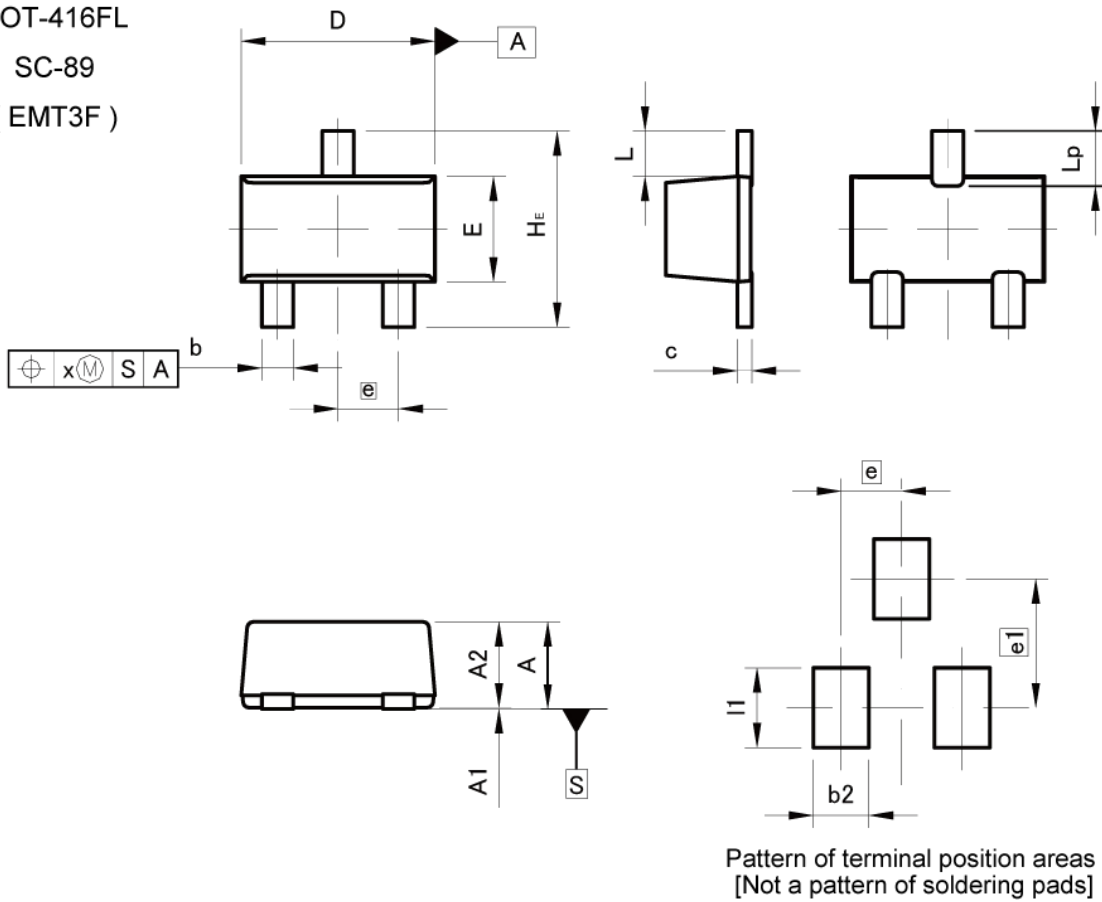
● Electrical characteristic curves ($T_a = 25^\circ\text{C}$)

Fig.5 Output voltage vs. output current



●Dimensions

SOT-416FL
SC-89
(EMT3F)



Pattern of terminal position areas
[Not a pattern of soldering pads]

| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.65 | 0.85 | 0.026 | 0.033 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| A2 | 0.60 | 0.80 | 0.024 | 0.031 |
| b | 0.21 | 0.36 | 0.008 | 0.014 |
| c | 0.08 | 0.18 | 0.003 | 0.007 |
| D | 1.50 | 1.70 | 0.059 | 0.067 |
| E | 0.76 | 0.96 | 0.030 | 0.038 |
| e | 0.50 | | 0.020 | |
| HE | 1.50 | 1.70 | 0.059 | 0.067 |
| L | 0.37 | | 0.015 | |
| Lp | 0.35 | 0.55 | 0.014 | 0.022 |
| x | - | 0.10 | - | 0.004 |
| DIM | MILIMETERS | | INCHES | |
| | MIN | MAX | MIN | MAX |
| b2 | - | 0.46 | - | 0.018 |
| e1 | - | 1.05 | - | 0.041 |
| l1 | - | 0.65 | - | 0.026 |

Dimension in mm/inches

Notice

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(Note1) Medical Equipment Classification of the Specific Applications

| JAPAN | USA | EU | CHINA |
|-----------|-----------|------------|-----------|
| CLASS III | CLASS III | CLASS II b | CLASS III |
| CLASS IV | | CLASS III | |

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
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 - [h] Use of the Products in places subject to dew condensation
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6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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8. Confirm that operation temperature is within the specified range described in the product specification.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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